

# S102S01/S102S02 S202S01/S202S02

## ■ Features

1. High radiation resin mold package
2. RMS ON-state current  
 $I_T$  : 8 Arms at  $T_C \leq 80^\circ\text{C}$   
(With heat sink)
3. Built-in zero-cross circuit  
(S102S02/S202S02)
4. High repetitive peak OFF-state voltage  
S102S01/S102S02       $V_{DRM}$ : MIN. 400V  
S202S01/S202S02       $V_{DRM}$ : MIN. 600V
5. Isolation voltage between input and output  
( $V_{iso}$  : 4 000V<sub>rms</sub>)
6. Approved by CSA, No. LR63705  
Recognized by UL, file No. E94758

## ■ Applications

1. Automatic vending machines, programmable controllers
2. Amusement equipment

## ■ Model Line-ups

	For 100V lines	For 200V lines
For phase control	<b>S102S01</b>	<b>S202S01</b>
No built-in zero-cross circuit		
Built-in zero-cross circuit	<b>S102S02</b>	<b>S202S02</b>

## ■ Absolute Maximum Ratings

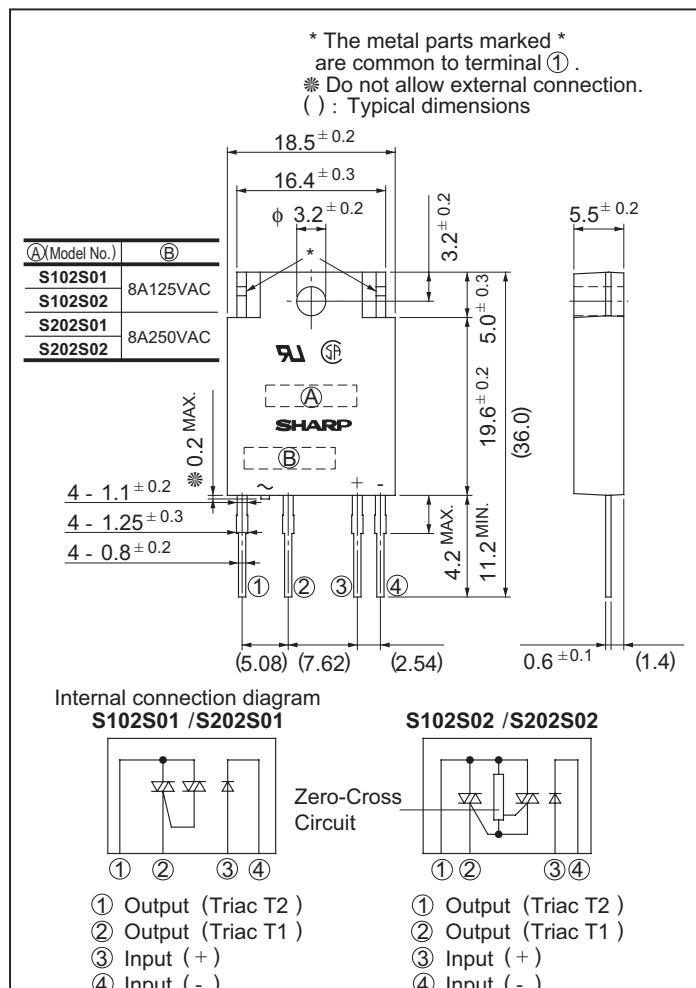
(Ta = 25°C)

Parameter		Symbol	Rating		Unit	*1 $T_C \leq 80^\circ\text{C}$ *2 50Hz sine wave, $T_j = 25^\circ\text{C}$ start
			S102S01 S102S02	S202S01 S202S02		
Input	Forward current	$I_F$	50		mA	*3 60Hz AC for 1 minute, 40 to 60% RH, Apply voltages between input and output, by the dielectric withstand voltage tester with zero- cross circuit. (Input and output shall be shorted respectively). (Note) When the isolation voltage is necessary at using external heat sink, please use the insulation sheet.
	Reverse voltage	$V_R$	6		V	
	* <sup>1</sup> RMS ON-state current	$I_T$	8		A <sub>rms</sub>	
	* <sup>2</sup> Peak one cycle surge current	$I_{surge}$	80		A	
Output	Repetitive peak OFF-state voltage	$V_{DRM}$	400	600	V	
	Non-repetitive peak OFF-state voltage	$V_{DSM}$	400	600	V	
	Critical rate of rise of ON-state current	$dI/dt$	50		A/ $\mu$ s	*4 For 10 seconds
	Operating frequency	f	45 to 65		Hz	
	* <sup>3</sup> Isolation voltage	$V_{iso}$	4 000		V <sub>rms</sub>	
	Operating temperature	$T_{opr}$	- 25 to + 100		°C	
	Storage temperature	$T_{stg}$	- 30 to + 125		°C	
	* <sup>4</sup> Soldering temperature	$T_{sol}$	260		°C	

## SIP Type SSR for Medium Power Control

## ■ Outline Dimensions

(Unit : mm)

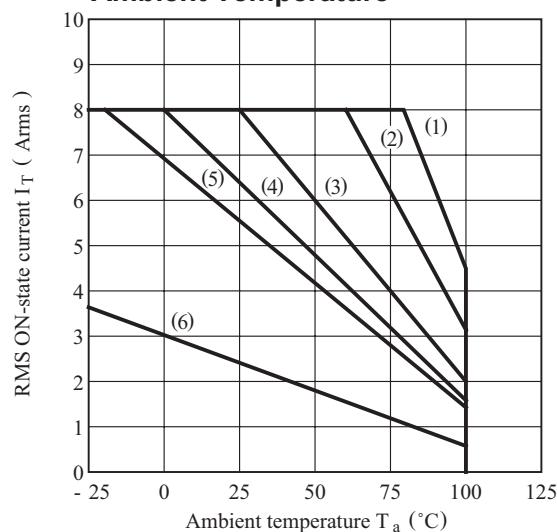


## ■ Electro-optical Characteristics

(Ta = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit		
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 20mA	-	1.2	1.4	V		
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 3V	-	-	10 <sup>-4</sup>	A		
Output	Repetitive peak OFF-state current	I <sub>DRM</sub>	V <sub>D</sub> = V <sub>DRM</sub>	-	-	10 <sup>-4</sup>	A		
	ON-state voltage	V <sub>T</sub>	Resistance load I <sub>F</sub> = 20mA, I <sub>T</sub> = 2 Arms	-	-	1.5	V <sub>rms</sub>		
	Holding current	I <sub>H</sub>	-	-	-	50	mA		
	Critical rate of rise of OFF-state voltage	dV/dt	V <sub>D</sub> = 2/3 • V <sub>DRM</sub>	30	-	-	V/μs		
	Critical rate of rise of commutating OFF-state voltage	(dV/dt) <sub>C</sub>	T <sub>j</sub> = 125°C, dI <sub>T</sub> /dt = - 4.0A/ms, V <sub>D</sub> = 400V	5	-	-	V/μs		
	Zero-cross voltage	V <sub>OX</sub>	I <sub>F</sub> = 8mA	-	-	35	V		
Transfer characteristics	Minimum trigger current	S102S01 S202S01	I <sub>FT</sub>	V <sub>D</sub> = 12V, R <sub>L</sub> = 30Ω	-	-	8	mA	
		S102S02 S202S02		V <sub>D</sub> = 6V, R <sub>L</sub> = 30Ω	-	-	8	mA	
	Isolation resistance	R <sub>ISO</sub>	DC500V, 40 to 60 % RH		10 <sup>10</sup>	-	-	Ω	
	Turn-on time	S102S01 S202S01	t <sub>on</sub>	AC 50Hz		-	-	1	ms
		S102S02 S202S02				-	-	10	ms
	Turn-off time	t <sub>off</sub>			-	-	10	ms	
Thermal resistance (Between junction and case)		R <sub>th(j - c)</sub>		-	-	4.5	-	°C/W	
Thermal resistance (Between junction and ambience)		R <sub>th(j - a)</sub>		-	-	40	-	°C/W	

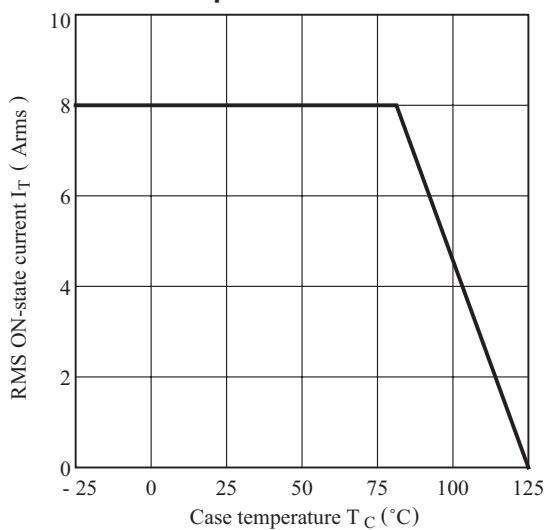
**Fig. 1 RMS ON-state Current vs.  
Ambient Temperature**



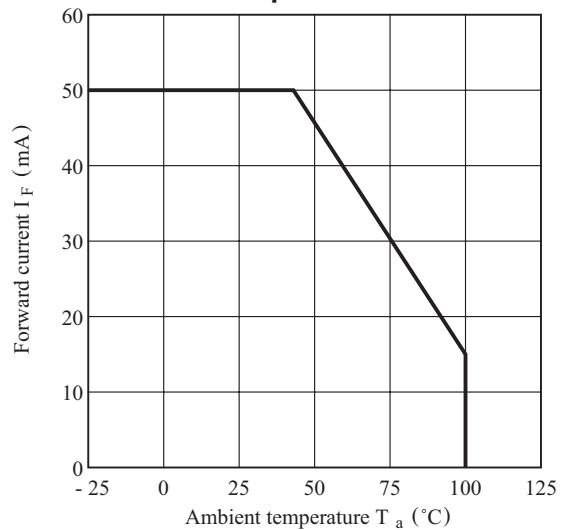
- (1) With infinite heat sink
- (2) With heat sink (200 x 200 x 2 mm Al plate)
- (3) With heat sink (100 x 100 x 2 mm Al plate)
- (4) With heat sink (75 x 75 x 2 mm Al plate)
- (5) With heat sink (50 x 50 x 2 mm Al plate)
- (6) Without heat sink

(Note) With the Al heat sink set up vertically, tighten the device at the center of the Al heat sink with a torque of 0.4N • m and apply thermal conductive silicone grease on the heat sink mounting plate. Forcible cooling shall not be carried out.

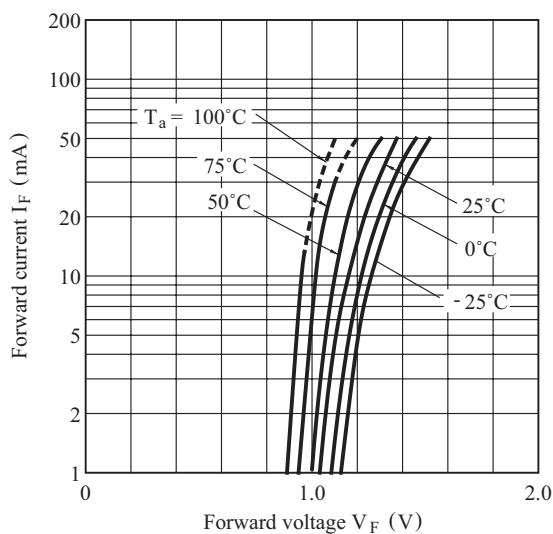
**Fig. 2 RMS ON-state Current vs. Case Temperature**



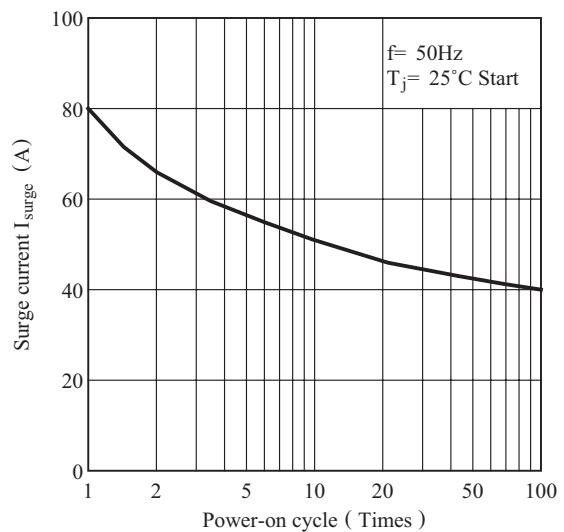
**Fig. 3 Forward Current vs. Ambient Temperature**



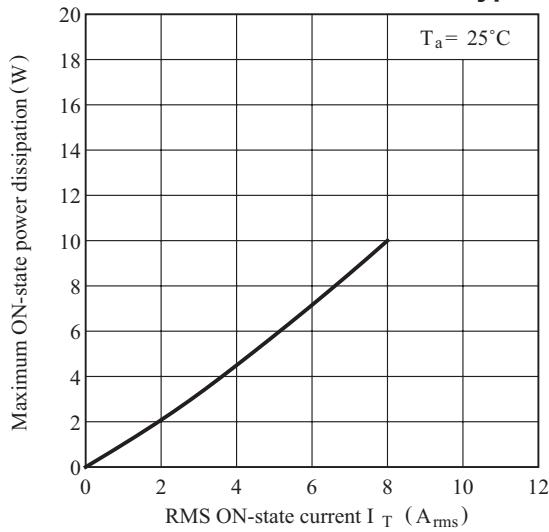
**Fig. 4 Forward Current vs. Forward Voltage**



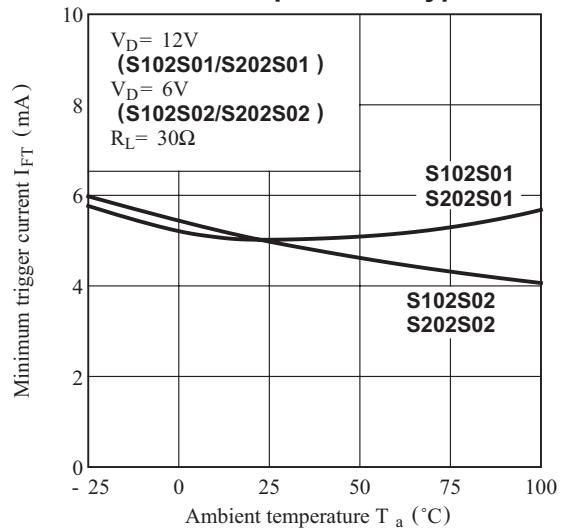
**Fig. 5 Surge Current vs. Power-on Cycle**



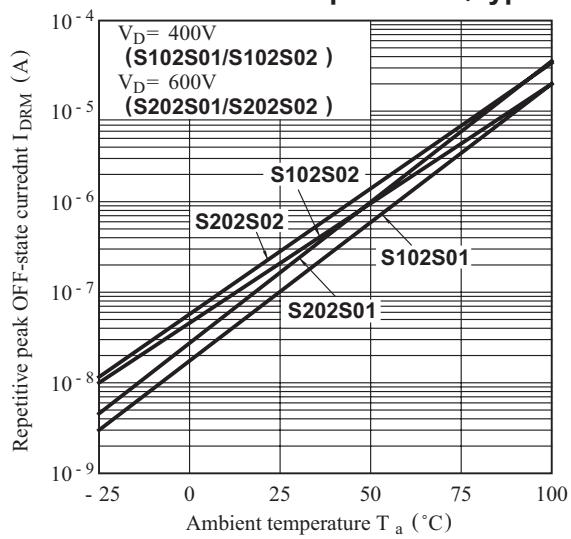
**Fig. 6 Maximum ON-state Power Dissipation vs. RMS ON-state Current (Typical Value)**



**Fig. 7 Minimum Trigger Current vs. Ambient Temperature (Typical Value)**



**Fig. 8 Repetitive Peak OFF-state Current  
vs. Ambient Temperature (Typical Value)**



- Please refer to the chapter “Precautions for Use”